NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

Rev. 9 — 15 November 2011

**Product data sheet** 

## 1. Product profile

#### 1.1 General description

NPN Resistor-Equipped Transistor (RET) family in Surface-Mounted Device (SMD) plastic packages.

#### Table 1. Product overview

| Type number | Package |        |          | PNP        | Package              |  |
|-------------|---------|--------|----------|------------|----------------------|--|
|             | NXP     | JEITA  | JEDEC    | complement | configuration        |  |
| PDTC144EE   | SOT416  | SC-75  | -        | PDTA144EE  | ultra small          |  |
| PDTC144EM   | SOT883  | SC-101 | -        | PDTA144EM  | leadless ultra small |  |
| PDTC144ET   | SOT23   | -      | TO-236AB | PDTA144ET  | small                |  |
| PDTC144EU   | SOT323  | SC-70  | -        | PDTA144EU  | very small           |  |

## 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

## **1.3 Applications**

- Digital applications in automotive and industrial segments
- Control of IC inputs

- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified
- Cost-saving alternative for BC847/857 series in digital applications
- Switching loads

#### 1.4 Quick reference data

#### Table 2. Quick reference data

| Symbol           | Parameter                 | Conditions | Min | Тур | Max | Unit |
|------------------|---------------------------|------------|-----|-----|-----|------|
| V <sub>CEO</sub> | collector-emitter voltage | open base  | -   | -   | 50  | V    |
| I <sub>O</sub>   | output current            |            | -   | -   | 100 | mA   |
| R1               | bias resistor 1 (input)   |            | 33  | 47  | 61  | kΩ   |
| R2/R1            | bias resistor ratio       |            | 0.8 | 1   | 1.2 |      |



NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

# 2. Pinning information

| Pin      | Description        | Simplified outline        | Graphic symbol       |
|----------|--------------------|---------------------------|----------------------|
| SOT23; S | OT323; SOT416      |                           |                      |
| 1        | input (base)       | _                         |                      |
| 2        | GND (emitter)      | 3                         |                      |
| 3        | output (collector) | 12                        | 1 R1<br>R2<br>sym007 |
| SOT883   |                    |                           |                      |
| 1        | input (base)       |                           |                      |
| 2        | GND (emitter)      |                           |                      |
| 3        | output (collector) | 2 Transparent<br>top view | 1 R1 R2 Sym007       |

## 3. Ordering information

| Type number | Package | Package   |         |  |  |  |  |
|-------------|---------|---|---------|--|--|--|--|
|             | Name    | Description   | Version |  |  |  |  |
| PDTC144EE   | SC-75   | plastic surface-mounted package; 3 leads  | SOT416  |  |  |  |  |
| PDTC144EM   | SC-101  | leadless ultra small plastic package; 3 solder lands; body 1.0 $\times$ 0.6 $\times$ 0.5 mm | SOT883  |  |  |  |  |
| PDTC144ET   | -       | plastic surface-mounted package; 3 leads  | SOT23   |  |  |  |  |
| PDTC144EU   | SC-70   | plastic surface-mounted package; 3 leads  | SOT323  |  |  |  |  |

## 4. Marking

| Table 5. Marking codes |                             |
|------------------------|-----------------------------|
| Type number            | Marking code <sup>[1]</sup> |
| PDTC144EE              | 08                          |
| PDTC144EM              | E7                          |
| PDTC144ET              | *08                         |
| PDTC144EU              | *08                         |

[1] \* = placeholder for manufacturing site code

PDTC144E\_SER
Product data sheet

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NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

## 5. Limiting values

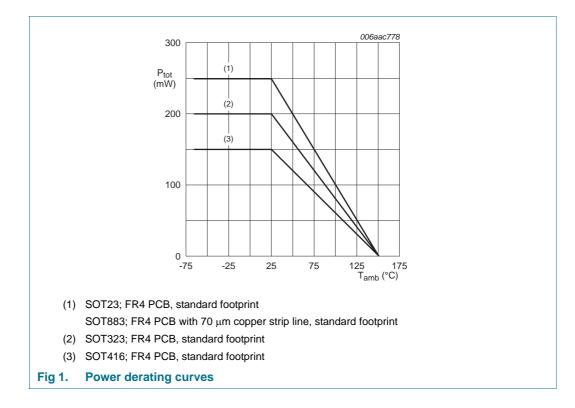
| Symbol           | Parameter                 | Conditions                    | Min          | Max  | Unit |
|------------------|---------------------------|-------------------------------|--------------|------|------|
| V <sub>CBO</sub> | collector-base voltage    | open emitter                  | -            | 50   | V    |
| V <sub>CEO</sub> | collector-emitter voltage | open base                     | -            | 50   | V    |
| V <sub>EBO</sub> | emitter-base voltage      | open collector                | -            | 10   | V    |
| VI               | input voltage             |                               |              |      |      |
|                  | positive                  |                               | -            | +40  | V    |
|                  | negative                  |                               | -            | -10  | V    |
| lo               | output current            |                               | -            | 100  | mA   |
| I <sub>CM</sub>  | peak collector current    | single pulse; $t_p \leq 1 ms$ | -            | 100  | mA   |
| P <sub>tot</sub> | total power dissipation   | $T_{amb} \le 25 \ ^{\circ}C$  |              |      |      |
|                  | PDTC144EE (SOT416)        |                               | [1][2] _     | 150  | mW   |
|                  | PDTC144EM (SOT883)        |                               | [2][3]       | 250  | mW   |
|                  | PDTC144ET (SOT23)         |                               | <u>[1]</u> - | 250  | mW   |
|                  | PDTC144EU (SOT323)        |                               | <u>[1]</u> - | 200  | mW   |
| Tj               | junction temperature      |                               | -            | 150  | °C   |
| T <sub>amb</sub> | ambient temperature       |                               | -65          | +150 | °C   |
| T <sub>stg</sub> | storage temperature       |                               | -65          | +150 | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70 µm copper strip line, standard footprint.

NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 



## 6. Thermal characteristics

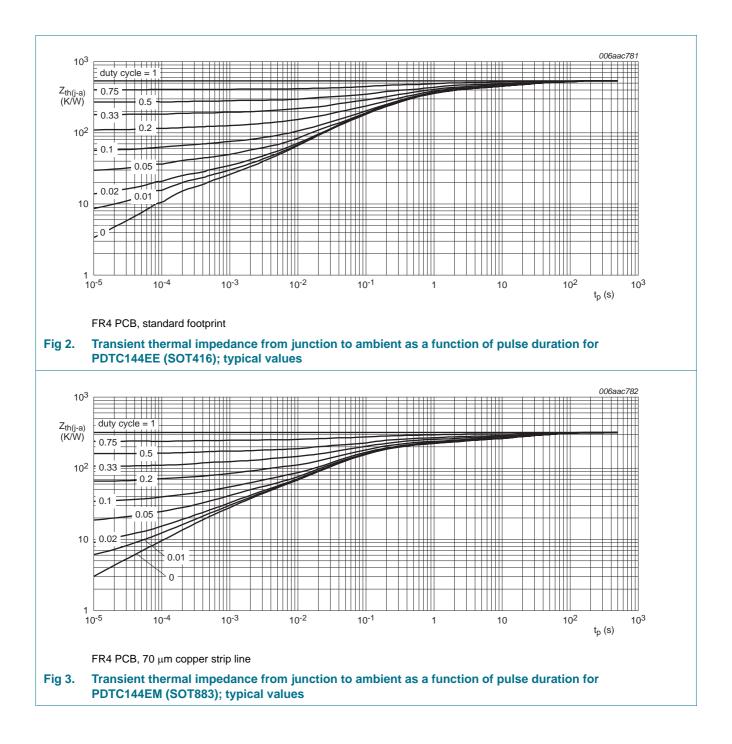
| Table 7.             | Thermal characteristics                     |             |            |     |     |     |      |
|----------------------|---|-------------|------------|-----|-----|-----|------|
| Symbol               | Parameter                                   | Conditions  |            | Min | Тур | Max | Unit |
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air |            |     |     |     |      |
|                      | PDTC144EE (SOT416)                          |             | [1][2]     | -   | -   | 830 | K/W  |
|                      | PDTC144EM (SOT883)                          |             | [2][3]     | -   | -   | 500 | K/W  |
|                      | PDTC144ET (SOT23)                           |             | <u>[1]</u> | -   | -   | 500 | K/W  |
|                      | PDTC144EU (SOT323)                          |             | <u>[1]</u> | -   | -   | 625 | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

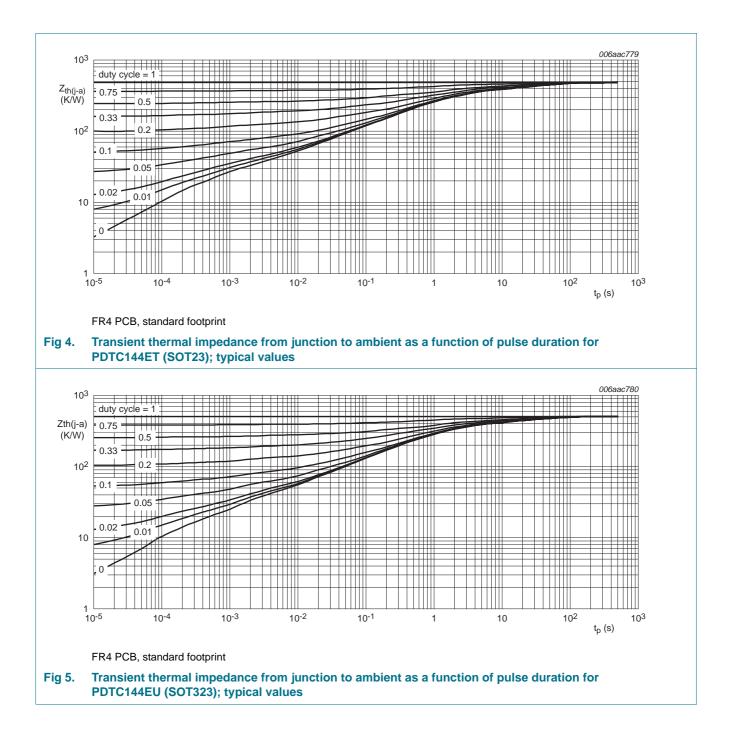
[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70  $\mu$ m copper strip line, standard footprint.

# **PDTC144E series**



# **PDTC144E series**



NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

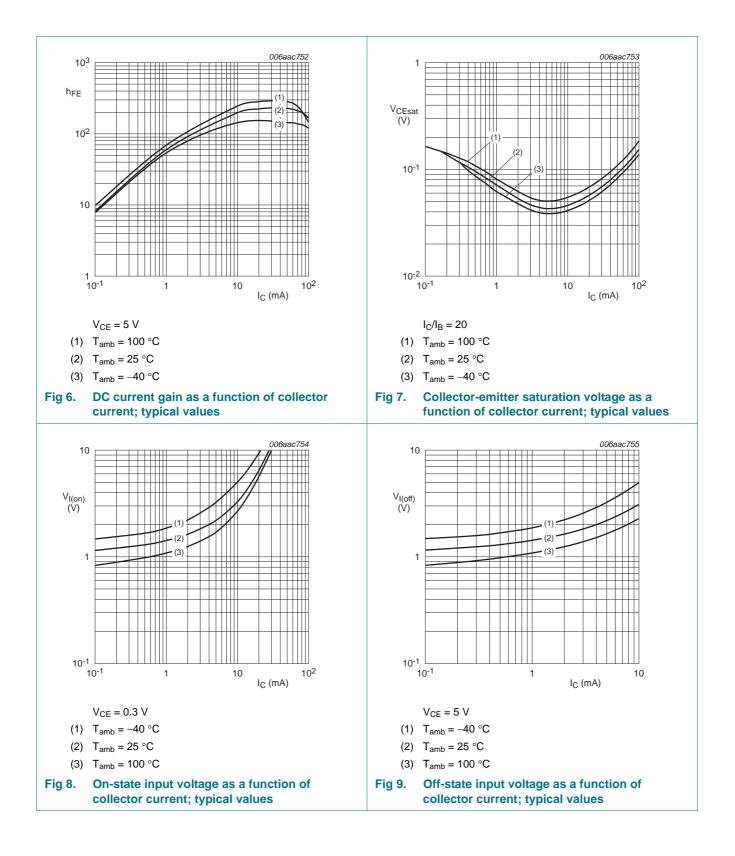
## 7. Characteristics

| Symbol              | Parameter                               | Conditions   |            | Min | Тур | Max | Unit |
|---------------------|---|--|------------|-----|-----|-----|------|
| I <sub>CBO</sub>    | collector-base cut-off<br>current       | $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$                               |            | -   | -   | 100 | nA   |
| I <sub>CEO</sub>    | collector-emitter                       | $V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$                               |            | -   | -   | 1   | μA   |
|                     | cut-off current                         | V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0 A;<br>T <sub>j</sub> = 150 °C |            | -   | -   | 5   | μA   |
| I <sub>EBO</sub>    | emitter-base cut-off<br>current         | $V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$                      |            | -   | -   | 90  | μA   |
| h <sub>FE</sub>     | DC current gain                         | $V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$                             |            | 80  | -   | -   |      |
| V <sub>CEsat</sub>  | collector-emitter<br>saturation voltage | $I_{C}$ = 10 mA; $I_{B}$ = 0.5 mA  |            | -   | -   | 150 | mV   |
| V <sub>I(off)</sub> | off-state input voltage                 | $V_{CE}$ = 5 V; $I_C$ = 100 $\mu$ A                                      |            | -   | 1.2 | 0.8 | V    |
| V <sub>I(on)</sub>  | on-state input voltage                  | $V_{CE}$ = 0.3 V; $I_{C}$ = 2 mA   |            | 3   | 1.6 | -   | V    |
| R1                  | bias resistor 1 (input)                 |  |            | 33  | 47  | 61  | kΩ   |
| R2/R1               | bias resistor ratio                     |  |            | 0.8 | 1   | 1.2 |      |
| C <sub>c</sub>      | collector capacitance                   | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$<br>f = 1 MHz           |            | -   | -   | 2.5 | pF   |
| f <sub>T</sub>      | transition frequency                    | V <sub>CE</sub> = 5 V; I <sub>C</sub> = 10 mA;<br>f = 100 MHz            | <u>[1]</u> | -   | 230 | -   | MHz  |

[1] Characteristics of built-in transistor

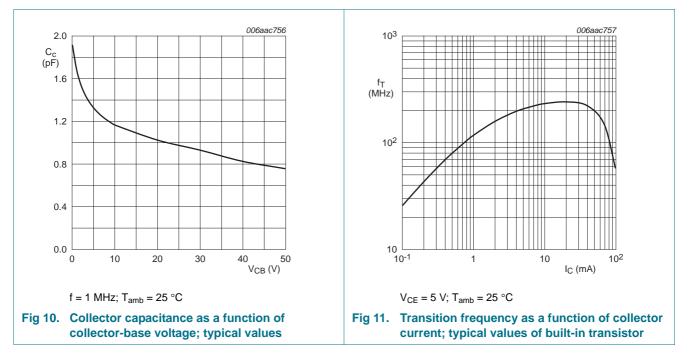
PDTC144E\_SER
Product data sheet

# **PDTC144E series**



# **PDTC144E series**

NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 



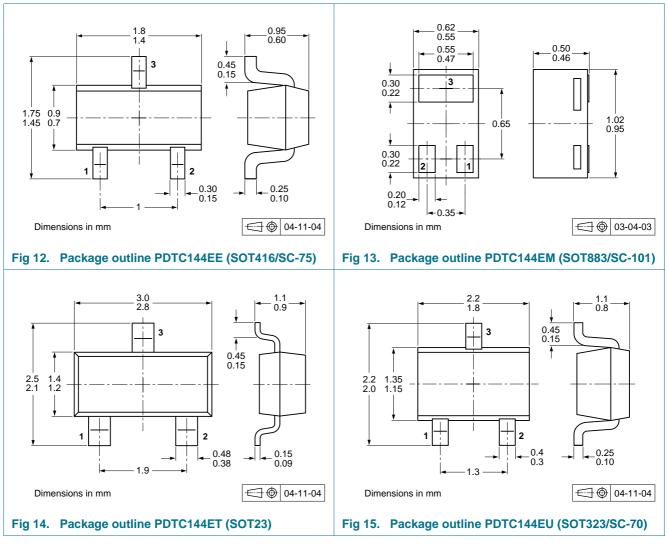
## 8. Test information

## 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

#### **Package outline** 9.



## **10. Packing information**

#### Table 9. **Packing methods**

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

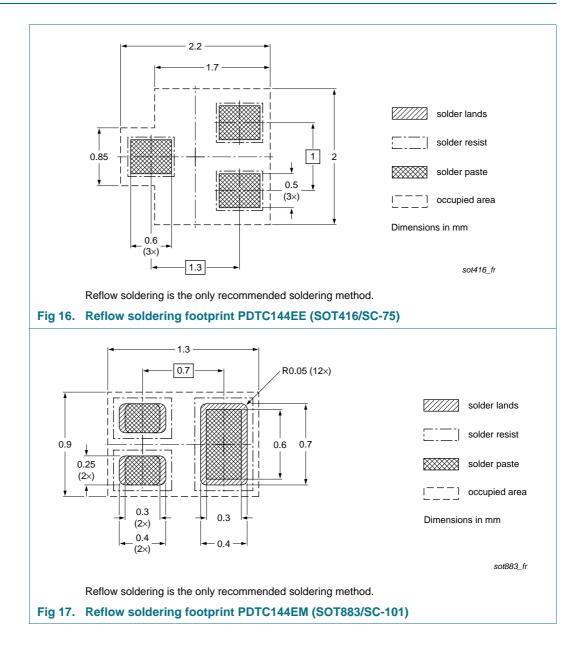
| Type number | Package | Description                    | Packing quantity |      |       |
|-------------|---------|--------------------------------|------------------|------|-------|
|             |         |                                | 3000             | 5000 | 10000 |
| PDTC144EE   | SOT416  | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |
| PDTC144EM   | SOT883  | 2 mm pitch, 8 mm tape and reel | -                | -    | -315  |
| PDTC144ET   | SOT23   | 4 mm pitch, 8 mm tape and reel | -215             | -    | -235  |
| PDTC144EU   | SOT323  | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |

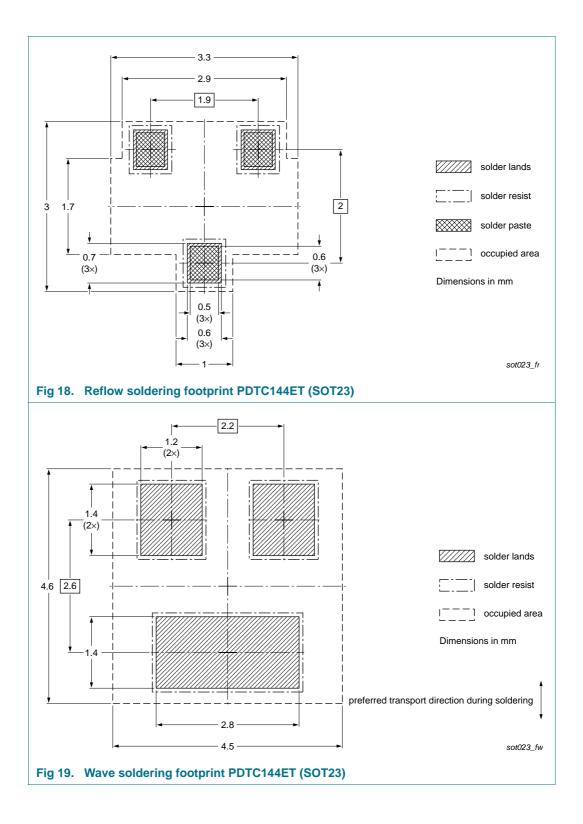
[1] For further information and the availability of packing methods, see Section 14.

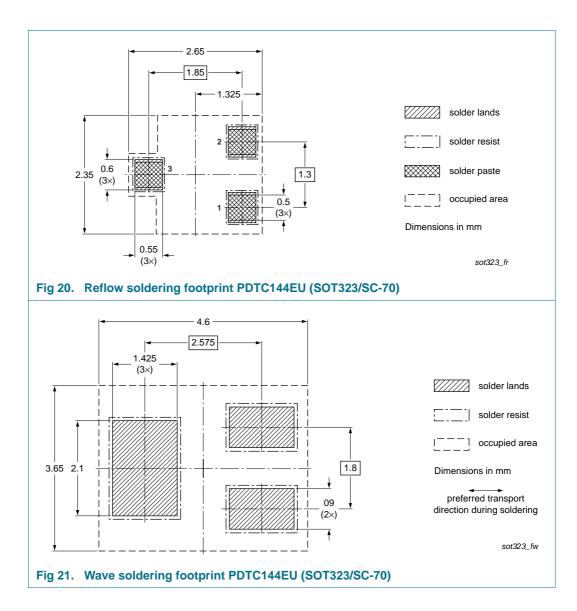
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NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

## 11. Soldering







NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

## 12. Revision history

| Document ID         | Release date  | Data sheet status                    | Change notice | Supersedes          |  |  |  |
|---------------------|---|--------------------------------------|---------------|---------------------|--|--|--|
| PDTC144E_SER v.9    | 20111115  | Product data sheet                   | -             | PDTC144E_SERIES v.8 |  |  |  |
| Modifications:      | <ul> <li>The format of this document has been redesigned to comply with the new identity<br/>guidelines of NXP Semiconductors.</li> </ul>                   |                                      |               |                     |  |  |  |
|                     | <ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>  |                                      |               |                     |  |  |  |
|                     | <ul> <li>Type numbers PDTC144EEF, PDTC144EK and PDTC144ES removed.</li> </ul>   |                                      |               |                     |  |  |  |
|                     | <u>Section 1 "Product profile"</u> : updated  |                                      |               |                     |  |  |  |
|                     | <ul> <li><u>Section 3 "Ordering information"</u>: updated</li> </ul>  |                                      |               |                     |  |  |  |
|                     | <u>Section 4 "Marking</u> ": updated  |                                      |               |                     |  |  |  |
|                     | • Figure 1 to 11: added   |                                      |               |                     |  |  |  |
|                     | <ul> <li><u>Section 6 "Thermal characteristics"</u>: updated</li> </ul>   |                                      |               |                     |  |  |  |
|                     | <ul> <li><u>Table 8 "Characteristics"</u>: V<sub>i(on)</sub> redefined to V<sub>I(on)</sub> on-state input voltage, V<sub>i(off)</sub> redefined</li> </ul> |                                      |               |                     |  |  |  |
|                     | to $V_{I(off)}$ off-state input voltage, $I_{CEO}$ updated, $f_T$ added   |                                      |               |                     |  |  |  |
|                     | <u>Section 8 "Test information"</u> : added   |                                      |               |                     |  |  |  |
|                     | <ul> <li><u>Section 9 "Package outline"</u>: superseded by minimized package outline drawings</li> </ul>  |                                      |               |                     |  |  |  |
|                     | <u>Section 10 "Packing information"</u> : added   |                                      |               |                     |  |  |  |
|                     | <ul> <li><u>Section 11 "Soldering"</u>: added</li> </ul>  |                                      |               |                     |  |  |  |
|                     | <ul> <li>Section 13 '</li> </ul>  | <u>'Legal information</u> ": updated | l             |                     |  |  |  |
| PDTC144E_SERIES v.8 | 20040817  | Product data sheet                   | -             | PDTC144E_SERIES v.7 |  |  |  |
| PDTC144E_SERIES v.7 | 20040323  | Product specification                | -             | PDTC144E_SERIES v.6 |  |  |  |
| PDTC144E_SERIES v.6 | 20030414  | Product specification                | -             | -                   |  |  |  |

# Table 10 Pevision history

## **13. Legal information**

#### 13.1 Data sheet status

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

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[2] The term 'short data sheet' is explained in section "Definitions".

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#### NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

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## 14. Contact information

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# **PDTC144E series**

NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

## **15. Contents**

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